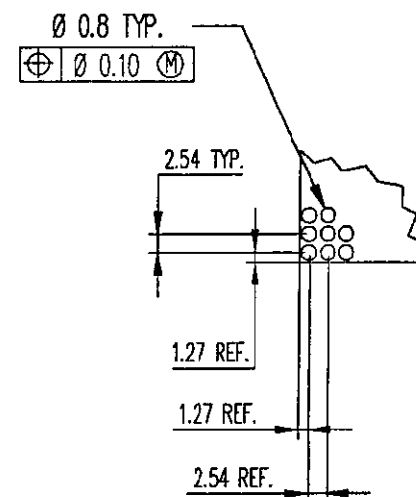
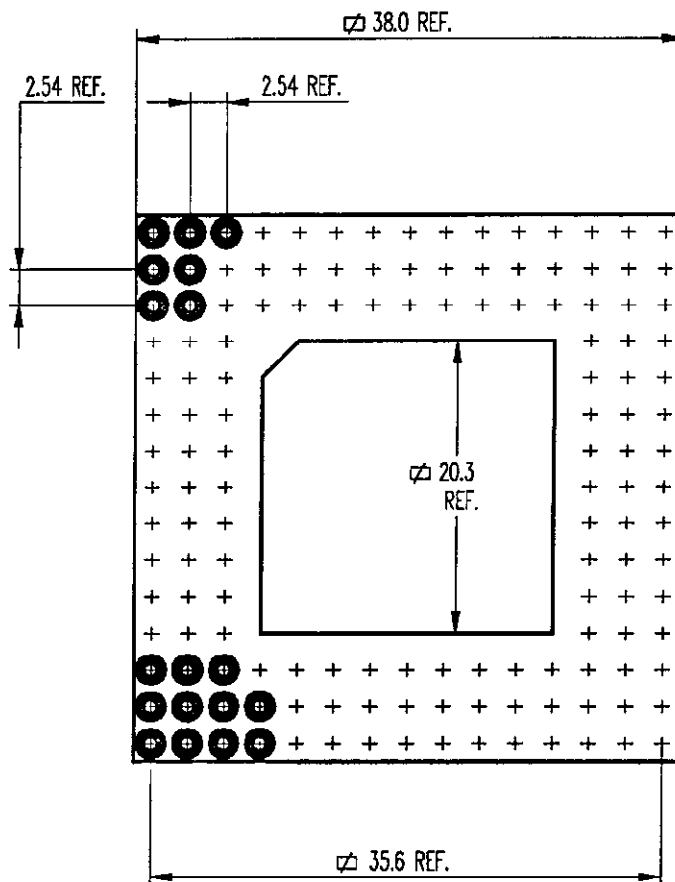
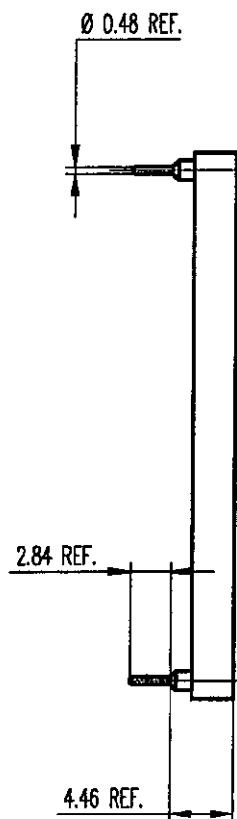


Ech. 1:1

RECOMMENDED P.C.
BOARD PATTERN

NOTES :

1. SOLDER TAIL PLATING
STANDARD 5 μ m Sn/Pb OVER 2-3 μ m Ni
PREFIX "1-" 0.25 μ m Au OVER 2-3 μ m Ni
2. INNER CONTACT PLATING
SUFFIX "-1" 0.25 μ m 18c. Au
SUFFIX "-2" 0.50 μ m 18c. Au
SUFFIX "-3" 0.75 μ m 18c. Au
SUFFIX "-4" 0.75 μ m 24c. Au
SUFFIX "-5" 5 μ m MIN. Sn/Pb
SUFFIX "-6" 0.1 μ m FLASH 24c. Au
3. INNER SPRING CONTACT ACCEPT $\varnothing$ 0.40
TO 0.56 OR RECTANGULAR PIN 0.25x0.45
4. MECHANICAL DATA WITH A $\varnothing$ 0.46 N3 FINISHED PIN
INSERTION FORCE SHALL BE 0.15N MAX. AND
WITHDRAWAL FORCE SHALL BE 0.05N MIN.

[illegible]